

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	("6717245").PN.	USPAT; USOCR	OR	OFF	2005/10/07 12:26
L2	1	("6107164").PN.	USPAT; USOCR	OR	OFF	2005/10/07 12:36
L3	2203	(@ad<"20000217") and (wafer with (polyimide or silicone or rubber or compliant or elastomer or elastomeric))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/07 13:08
L4	1120074	L and (cut or cutting or excision or saw or sawing or blade)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/07 12:38
L5	763	L3 and (cut or cutting or excision or saw or sawing or blade)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/07 12:38
L6	73140	L4 and (grind or grinding or polish or polishing or cmp)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/07 12:39
L7	169	L5 and (grind or grinding or polish or polishing or cmp)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/07 12:39
L8	2948	(@ad<"20000217") and (wafer with (polyimide or silicone or rubber or compliant or elastomer or elastomeric))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/07 13:35
L9	24	L8 and ((stress and (cure or harden))) with (polyimide or silicone or rubber or compliant or elastomer or elastomeric))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/07 13:14

L10	76	257/778.ccls. and ((stress and (wafer or chip or die)) with (polyimide or silicone or rubber or compliant or elastmer or elastomeric))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/07 13:35
L11	0	L10 and polyimide	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/07 13:19
L12	62	L10 and polyimide	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/07 13:23
L13	477	((stress and wafer)) with (polyimide or silicone or rubber or compliant or elastmer or elastomeric)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/07 14:09
L14	184	L13 and wafer and (@ad<"20000217")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/07 14:09
L15	97	((strain and wafer)) with (polyimide or silicone or rubber or compliant or elastmer or elastomeric)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/07 14:09
L16	25	L15 and (@ad<"20000217")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/07 14:10